

100Gb/s QSFP28 to 4×25Gb/s SFP28 Hybrid Passive Copper

PQSFP284-Tx

Features

- ◆ Supporting 100 Gbps to 4 x 25 Gbps
- ◆ Support data rates : 25.78Gb/s (per channel)
- ◆ IEEE 802.3bj 100GEBASE-CR4 and P802.3by compliant
- ◆ Compatible to SFP28 MSA and QSFP28 MSA
- ◆ Compatible to SFF-8402, SFF-8432 and SFF8665
- ◆ Maximum aggregate data rate: 100 Gb/s (4 x 25Gb/s)
- ◆ High-Density QSFP28 38-PIN and 4x SFP28 20-PIN Connector
- ◆ Temperature Range: 0~ 70 °C
- ◆ Copper link length up to 3m
- ◆ Power Supply : +3.3V
- ◆ Low crosstalk
- ◆ I2C based two-wire serial interface for EEPROM signature which can be customized
- ◆ ROHS Compliant



Applications

- ◆ Switches, Routers, and HBAs
- ◆ Data Centers

Description

The 100GE QSFP28 to 4x25GE SFP28 Passive cable assemblies are high performance, cost effective for SFP28 and QSFP28 equipment interconnects. The Hybrid cables are compliant with SFF-8402 and SFF-8665 specifications. They offer a low power consumption, short reach interconnect applications.

Each cable lane is capable of transmitting data at rates up to 25Gb/s, providing an aggregated rate of 100Gb/s.

Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units
Supply voltage	-0.3	3.6	V
Data input voltage	-0.3	3.6	V
Control input voltage	-0.3	3.6	V

Recommended Operating Environment

Parameter	Symbol	Min.	Typical	Max.	Unit
Case operating Temperature	TC	0		70	°C
Supply Voltage	VCCT, R	+3.13	3.3	+3.47	V
Power Dissipation	PD			0.1	W
Operating relative humidity		5	---	85	%

Electrical Specifications

Parameter	Minimum	Typical	Maximum	Units
Characteristic impedance	90	100	110	Ω
Time delay	---	---	4.5	ns/m
Time delay skew (in the same pair)	---	---	10	ps
Time delay skew (pair to pair)	---	---	50	ps

High Speed Characteristics

Parameter	Symbol	Min.	Typical	Max.	Unit	Note
Differential Impedance	RIN,P-P	90	100	110	Ω	
Insertion loss	SDD21	8		22.48	dB	At 12.8906 GHz
Differential Return Loss	SDD11	12.45		See 1	dB	At 0.05 to 4.1 GHz
	SDD22	3.12		See 2	dB	At 4.1 to 19 GHz
Common-mode to common-mode output return loss	SCC11	2			dB	At 0.2 to 19 GHz
	SCC22					
Differential to common-mode return loss	SCD11	12		See 3	dB	At 0.01 to 12.89
	SCD22	10.58		See 4		At 12.89 to 19 GHz
Differential to common Mode Conversion Loss	SCD21-IL	10			dB	At 0.01 to 12.89
				See 5		At 12.89 to 15.7
		6.3				At 15.7 to 19 GHz
Channel Operating Margin	COM	3			dB	

Notes:

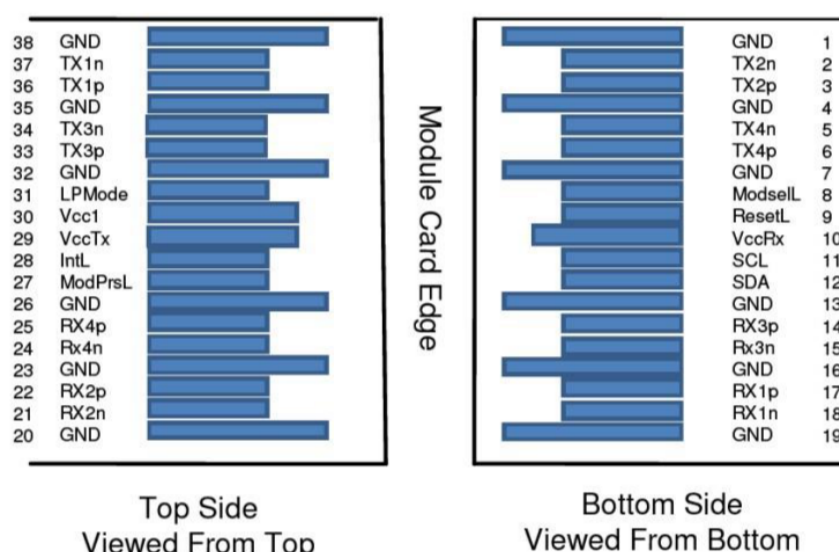
1. Reflection Coefficient given by equation $SDD11(dB) < 16.5 - 2 \times \sqrt{f}$, with f inGHz
2. Reflection Coefficient given by equation $SDD11(dB) < 10.66 - 14 \times \log_{10}(f/5.5)$, with f inGHz
3. Reflection Coefficient given by equation $SCD11(dB) < 22 - (20/25.78) \times f$, with f inGHz
4. Reflection Coefficient given by equation $SCD11(dB) < 15 - (6/25.78) \times f$, with f inGHz
5. Reflection Coefficient given by equation $SCD21(dB) < 27 - (29/22) \times f$, with f inGHz

QSFP28 Module Pad Layout

Pin	Logic	Symbol	Name/Description	Notes
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data	
3	CML-I	Tx2p	Transmitter Non-Inverted	
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data	
6	CML-I	Tx4p	Transmitter Non-Inverted	
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	
9	LVTTL-I	ResetL	Module Reset	
10		Vcc Rx	+3.3V Power Supply	2
11	LVCMSI/O	SCL	2-wire serial interface	
12	LVCMSI/O	SDA	2-wire serial interface data	
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Non-Inverted	
15	CML-O	Rx3n	Receiver Inverted Data	
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Non-Inverted Data	
18	CML-O	Rx1n	Receiver Inverted Data	
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data	
22	CML-O	Rx2p	Receiver Non-Inverted Data	
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data	
25	CML-O	Rx4p	Receiver Non-Inverted Data	
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	
28	LVTTL-O	IntL	Interrupt	
29		Vcc Tx	+3.3V Power supply	2
30		Vcc1	+3.3V Power supply	2
31	LVTTL-I	LPMode	Low Power Mode	
32		GND	Ground	1
33	CML-I	Tx3p	Transmitter Non-Inverted	
34	CML-I	Tx3n	Transmitter Inverted Data	
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Non-Inverted	
37	CML-I	Tx1n	Transmitter Inverted Data	
38		GND	Ground	1

Note 1: GND is the symbol for signal and supply (power) common for the QSFP28 module. All are common within the QSFP28 module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

Note2: VccRx, Vcc1 and VccTx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in Table 6. Recommended host board power supply filtering is showing Figure4. VccRx Vcc1 and VccTx may be internally connected within the QSFP28 Module in any combination. The connector pins are each rated for a maximum current of 500 mA.



SFP28 Pin Descriptions

Pin	Logic	Symbol	Name/Description	Notes
1		VeeT	Transmitter Ground	
2	LV-TTL-O	TX_Fault	N/A	1
3	LV-TTL-I	TX_DIS	Transmitter Disable	2
	LV-TTL-I/O	SDA	Tow Wire Serial Data	
5	LV-TTL-I	SCL	Tow Wire Serial Clock	
			Module present, connect	
7	LV-TTL-I	RS0	N/A	1
		LOS	LOS of Signal	2
9	LV-TTL-I	RS1	N/A	1
		VeeR	Reciever Ground	
		VeeR	Reciever Ground	
12	CML-O	RD-	Reciever Data Inverted	

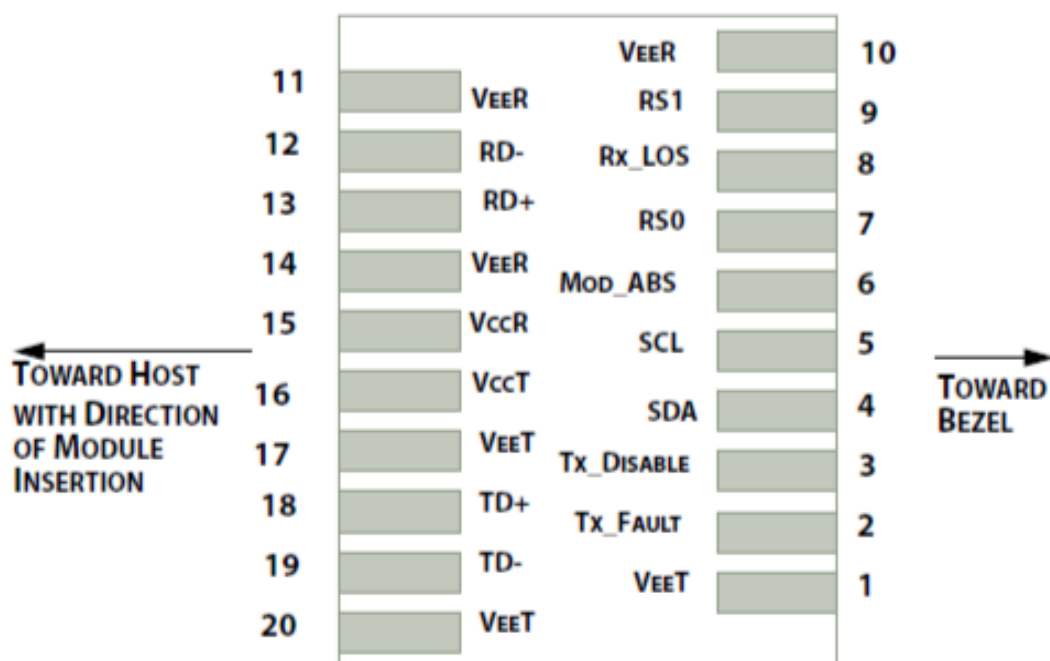
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13	CML-O	RD+	Reciever Data	
14		VeeR	Reciever Ground	
15		VccR	Reciever Supply 3.3V	
16		VccT	Transmitter Supply 3.3V	
17		VeeT	Transmitter Ground	
18	CML-I	TD+	Transmitter Data	
19	CML_I	TD-	Transmitter Data	
20		VeeT	Transmitter Ground	

Notes:

1. Signals not supported in SFP28 Copper pulled-downto VeeT with 30K ohms resistor
2. Passive cable assemblies do not support LOS and TX_DIS

Host PCB SFP28 pad contact assignment



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Mechanical Dimensions

